## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Hyung- Gu ROH	05/13/2009
Byung- Chul AHN	05/15/2009
Hee- Dong CHOI	05/13/2009
Seong- Moh SEO	05/13/2009
Jun- Min LEE	05/13/2009

#### **RECEIVING PARTY DATA**

Name:	LG DISPLAY CO., LTD.	
Street Address:	s: 20 Yoido-Dong,Youngdungpo-Gu	
City:	Seoul	
State/Country:	State/Country: REPUBLIC OF KOREA	

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12486453

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 053785-5311

NAME OF SUBMITTER: Robert J. Goodell

**Total Attachments: 2** 

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**PATENT** REEL: 022839 FRAME: 0437

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PATENT REEL: 022839 FRAME: 0438

ATTORNEY DOCKET NO.: 053785-5311 SOLE/JOINT INVENTION (U.S. Rights Only)

## ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

# ARRAY SUBSTRATE INCLUDING THIN FILM TRANSISTOR AND

	METHOD OF FABRICATING THE SAME					
	for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on, (Application No); and					
	WHEREAS, LG Display Co., Ltd., a corporation of Korea, whose post office address is 20 Yoido-Dong, YoungDungpo-Gu, Seoul, Korea (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;					
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and MY/OUR entire right, title, and interest in and to this invention and this application, and all divisit continuations thereof, and all Letters Patent of the United States which may be granted thereon, at reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Tradem the United States to issue all Letters Patent for this invention to assignee, its successors and assign accordance with the terms of this Assignment;						
	AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.					
Ju	AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. 12/486, 453, filed June 17, 2009) the filing date and application number of said application when known.  IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).					
	Full Name of Sole or First Assignor Assignor's Şignature Date					
	Hyung-Gu Roh Hyung-Gu Roh 13. May 2009					
	Address 5-503 Jungang sangga APT, Hwacheon-dong, Jinhae-si,  Gyeongsangnam-do, 645-190 REPUBLIC OF KOREA  Citizenship  KOREA					
	Names of additional inventors attached ⊠Yes □ No					

DB1/62842919.1

	Ausianada Signature	Date $A = A$
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841 Republic of Korea		Date
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	Citizenship	
Address		
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Address		
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Names of additional inventors attached Ye		
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